

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT														
NATURE OF CONVEYANCE:	Corrective Assignment to correct the Add Inventors 4-6: 4. Kazuhiro OGAWA; 5. Atsuro ISEDA; 6. Mitsuru YOSHIZAWA previously recorded on Reel 028326 Frame 0456. Assignor(s) hereby confirms the inventors 4-6 to the Assignment..														
CONVEYING PARTY DATA															
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Hiroyuki HIRATA</td> <td>05/11/2012</td> </tr> <tr> <td>Hirokazu OKADA</td> <td>05/14/2012</td> </tr> <tr> <td>Hiroyuki SEMBA</td> <td>05/11/2012</td> </tr> <tr> <td>Kazuhiro OGAWA</td> <td>05/11/2012</td> </tr> <tr> <td>Atsuro ISEDA</td> <td>05/14/2012</td> </tr> <tr> <td>Mitsuru YOSHIZAWA</td> <td>05/14/2012</td> </tr> </tbody> </table>		Name	Execution Date	Hiroyuki HIRATA	05/11/2012	Hirokazu OKADA	05/14/2012	Hiroyuki SEMBA	05/11/2012	Kazuhiro OGAWA	05/11/2012	Atsuro ISEDA	05/14/2012	Mitsuru YOSHIZAWA	05/14/2012
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CORRESPONDENCE DATA															
Fax Number:	(703)504-9415														
Phone:	2028351111														
Email:	tlim@clarkbrody.com														
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>															
Correspondent Name:	Clark & Brody														
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CH \$40.00 13472640

ATTORNEY DOCKET NUMBER:	12049-0112
NAME OF SUBMITTER:	Christopher W. Brody
<p>Total Attachments: 15 source=AS1#page1.tif source=AS1#page2.tif source=AS1#page3.tif source=AS1#page4.tif source=AS1#page5.tif source=AS1#page6.tif source=AS1#page7.tif source=AS1#page8.tif source=AS1#page9.tif source=AS1#page10.tif source=AS1#page11.tif source=AS1#page12.tif source=AS1#page13.tif source=AS1#page14.tif source=AS1#page15.tif</p>	

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Total Attachments: 2 source=assn1#page1.tif source=assn1#page2.tif											

ASSIGNMENT

This is an Assignment of the following rights, title and interest:

- ☒ United States of America rights, title and interest in the invention
- ☐ Foreign rights, title and interest in the invention
- ☒ International Application No. PCT/JP2010/071954
- Date of Filing: 8 December 2010
- ☐ For which an application for a U.S. Patent was executed on _____
- ☒ United States Patent Application Serial No. 13/472,640
- Date of Filing: May 16, 2012

Title of the Invention: **AUSTENITIC HEAT RESISTANT ALLOY**

Inventors (Assignors): **Hiroyuki HIRATA, Hirokazu OKADA, Hiroyuki SEMBA, Kazuhiro OGAWA, Atsuro ISEDA, and Mitsuru YOSHIZAWA**

Assignee(s): **SUMITOMO METAL INDUSTRIES, LTD., of 5-33, Kitahama 4-chome, Chuo-ku, Osaka-shi, Osaka 541-0041, Japan**

Whereas, we, the above-identified Inventors, have invented certain new and useful improvements in the Invention identified above and described in the above-identified patent application(s) and/or patent(s) (hereinafter referred to as "Invention");

And, whereas we desire to assign our above-identified rights, title and interest in the Invention to the above-identified assignee;

Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

We hereby assign, sell and transfer our above-identified rights, title and interest in said Invention, said applications(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, which may be granted or have granted for said Invention; and in and to any and all reissues and reexaminations thereof; and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States, unto said Assignee.

And we hereby authorize and request the Commissioner of Patents and Trademarks to issue any United States Letters Patent which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto;

And we further agree to sign and execute all necessary and lawful future documents, including applications, for filing divisions, continuations and continuations-in-part of said application for patent, and/or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignee or its Designee(s) may from time to time require and prepare at its own expense.

Hiroyuki Hirata
Signature: **Hiroyuki HIRATA**

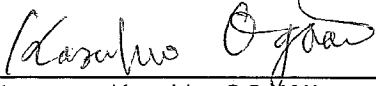
11/05/2012
Date

Hirokazu Okada
Signature: **Hirokazu OKADA**

14/05/2012
Date

Hiroyuki Semba
Signature: **Hiroyuki SEMBA**

11/05/2012
Date



Signature: Kazuhiro OGAWA

11/05/2012

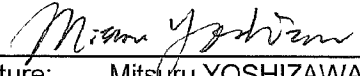
Date



Signature: Atsuro ISEDA

14/05/2012

Date



Signature: Mitsuru YOSHIKAWA

14/05/2012

Date